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H8/300H Tiny Series

Serial Data Reception in Synchronous Mode

Introduction

Four bytes of 8-bit data are received by serial data transfer in synchronous mode.

Target Device

H8/300H Tiny Series H8/3664

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1. Specification

1. Four bytes of 8-bit data are received by serial data transfer in synchronous mode, as shown in figure 1.
2. Data is received with an external clock used as the transmit/receive clock (serial clock).
3. The data length of the receive data is eight bits, and data is received in the LSB-first format, starting from the least significant bit.

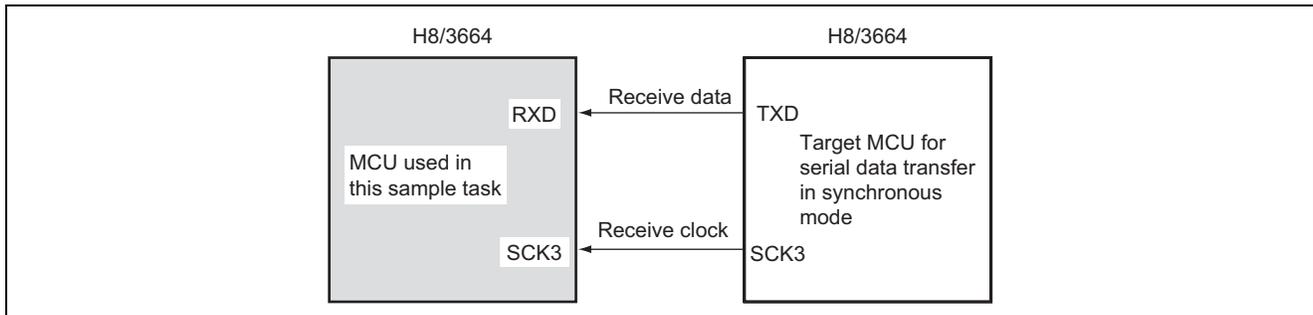


Figure 1 Serial Data Reception in Synchronous Mode

2. Description of Functions Used

1. In this sample task, serial data is received in synchronous mode via the serial communication interface (SCI). Figure 2 is a block diagram of serial data reception in synchronous mode. The elements of the block diagram are described below.
 - Only overrun errors are detected as receive errors.
 - In synchronous mode, the data length is eight bits.
 - The receive shift register (RSR) is a register used to receive serial data. Serial data input to RSR from the RXD pin is set in the order in which it is received, starting from the LSB (bit 0), and converted to parallel data. When one byte of data is received, it is transferred to RDR automatically. RSR cannot be read from or written to directly by the CPU.
 - The receive data register (RDR) is an 8-bit register that stores received serial data. When reception of one byte of data is finished, the received data is transferred from RSR to RDR, and the receive operation is completed. RSR is then enabled for reception. RSR and RDR are double-buffered, allowing consecutive receive operations. RDR is a read-only register, and cannot be written to by the CPU.
 - The transmit shift register (TSR) is a register used to transmit serial data. Transmit data is first transferred from TDR to TSR, and serial data transmission is carried out by sending the data to the TXD pin in order, starting from the LSB (bit 0). When one byte of data is transmitted, the next byte of transmit data is automatically transferred from TDR to TSR, and transmission is started. Data transfer from TDR to TSR is not performed if no data has been written to TDR (if bit TDRE is set to 1). TSR cannot be read from or written to directly by the CPU.
 - The transmit data register (TDR) is an 8-bit register that stores transmit data. When TSR is found to be empty, the transmit data written in TDR is transferred to TSR, and serial data transmission is started. Continuous transmission is possible by writing the next transmit data to TDR during TSR serial data transmission. TDR can be read from or written to by the CPU at any time.
 - The serial mode register (SMR) is an 8-bit register used to set the serial data transfer format and to select the clock source for the baud rate generator.
 - Serial control register 3 (SCR3) is an 8-bit register for selecting transmit or receive operation and the serial clock source.
 - The serial status register (SSR) is an 8-bit register containing status flags that indicate the operational status of SCI3, and multiprocessor bits. Bits TDRE, RDRF, OER, PER, and FER can only be cleared to 0.
 - The serial clock can be selected from a total of nine clocks: eight internal clocks and an external clock. When an internal clock is selected, the SCK3 pin functions as an output pin. When clock consecutive output mode is selected, the selected clock is consecutively output from the SCK3 pin. When an external clock is selected, the SCK3 pin functions as an input pin.
 - In this sample task, the source of the serial clock (baud rate generator) is the external clock.
 - The SCI3 data transfer format uses a fixed 8-bit data length, and data is transmitted in the LSB-first format, starting from the least significant bit. Transmit data is output from one falling edge of the serial clock until the next falling edge. Receive data is latched at the rising edge of the serial clock.
 - In this sample task, the data transfer format is set to an 8-bit data length, and 8-bit data is received.
 - The SCI3 clock (SCK3) pin is the SCI3 clock I/O pin.
 - The SCI3 receive data input (RXD) pin is the input pin for SCI3 receive data.

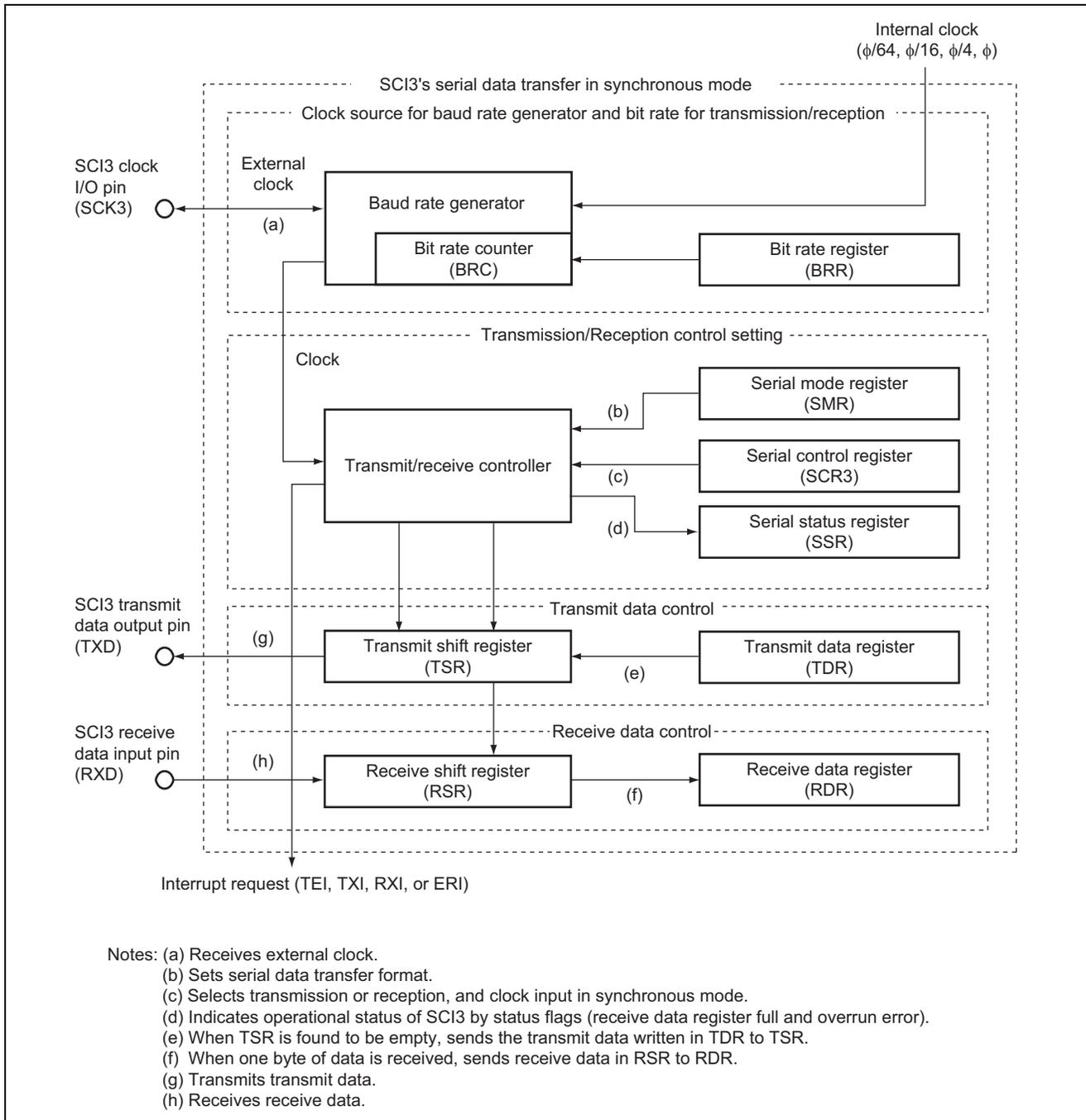


Figure 2 Serial Data Reception in Synchronous Mode

2. Table 1 lists the function allocation for this sample task. The functions listed in table 1 are allocated for serial data reception in synchronous mode.

Table 1 Function Allocation

Function	Function Assignment
RSR	Receives serial data
RDR	Stores receive data
SMR	Sets the serial data transfer format
SSR	Status flags indicating the operational status of SCI3
SCR3	Selects receive operation and sets the SCK3 pin to function as a clock input pin
SCK3	SCI3 clock input pin
RXD	SCI3 receive data input pin

3. Operational Description

Figure 3 shows this sample task's principle of operation. The hardware and software processing shown in figure 3 performs serial data reception in synchronous mode.

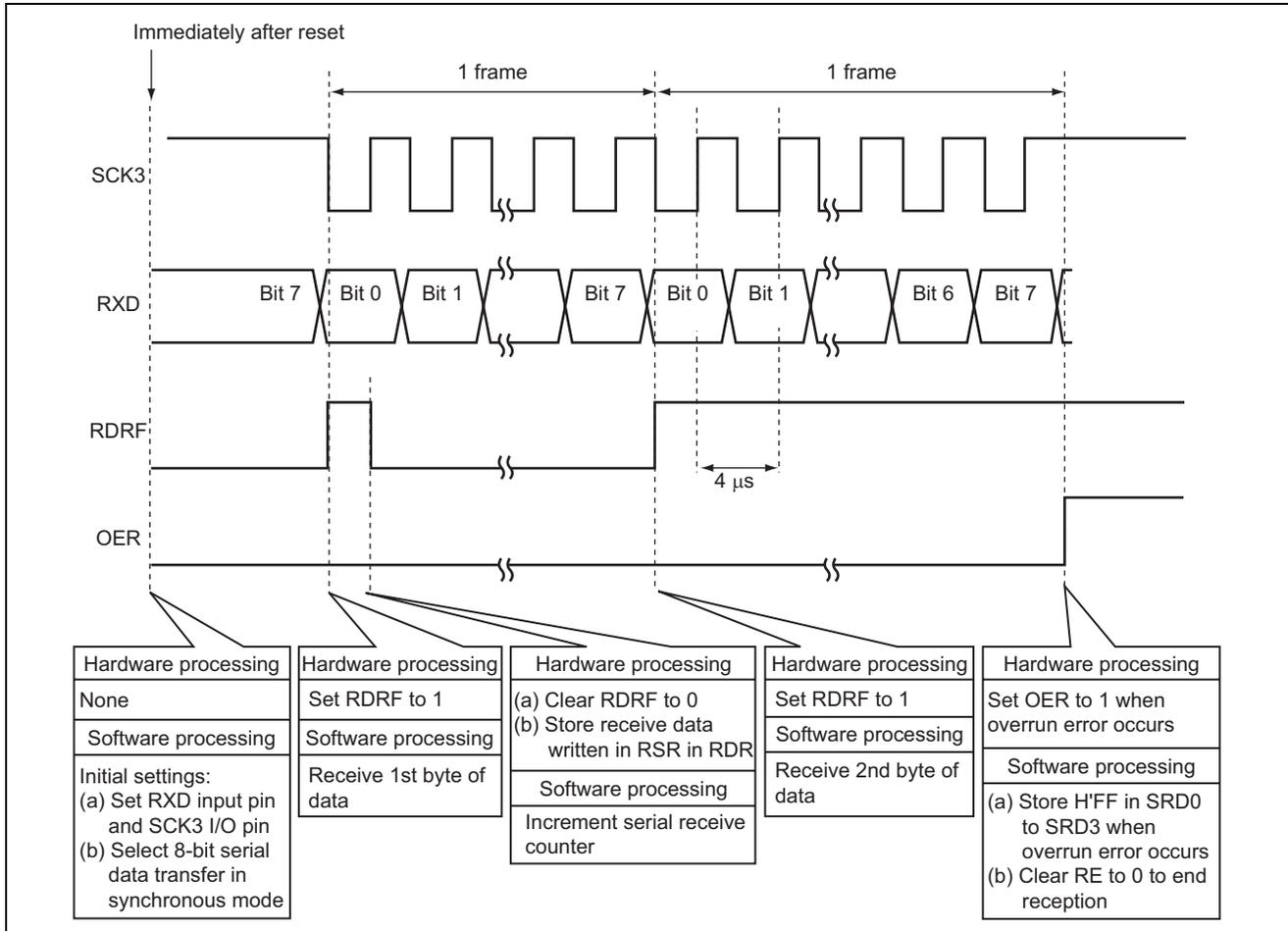


Figure 3 Operation Principle: Serial Data Reception in Synchronous Mode

4. Description of Software

4.1 Description of Modules

Table 2 describes the software used in this sample task.

Table 2 Description of Module

Module Name	Label Name	Function
Main routine	main	Selects serial data reception in synchronous mode, stores H'FF in SRD0 to SRD3 when a receive error occurs, and stops SCI3 after four bytes of data have been received.

4.2 Description of Argument

Table 3 describes the argument used in this sample task.

Table 3 Description of Argument

Argument Name	Function	Used in	Data Length	I/O
SRD0 to SRD3	Serial receive data in synchronous mode	Main routine	1 byte	Input

4.3 Description of Internal Registers

Table 4 describes the internal registers used in this sample task.

Table 4 Description of Internal Registers

Register Name	Functional Description	Address	Setting
SMR	COM Serial mode register (communication mode): When COM is set to 1, the communication mode is set to synchronous mode.	H'FFA8 Bit 7	1
	MP Serial mode register (multiprocessor mode): This bit must be cleared to 0 (multiprocessor communication function disabled) in synchronous mode.	H'FFA8 Bit 2	0
SCR3	RE Serial control register 3 (receive enable): When RE is set to 1, receive operation is enabled.	H'FFAA Bit 4	1
	CKE1 Serial control register 3 (clock enable):	H'FFAA	CKE1 = 0
	CKE0 When CKE1 is set to 1 and CKE0 is cleared to 0, the clock source is set to an external clock and the SCK3 pin functions as a clock input pin in synchronous mode.	Bit 1 Bit 0	CKE0 = 1
RDR	Receive data register: 8-bit register that stores the receive data.	H'FFAD	—
SSR	RDRF Serial status register (receive data register full): When RDRF is cleared to 0, no receive data is stored in RDR. When RDRF is set to 1, receive data is stored in RDR.	H'FFAC Bit 6	1
	OER Serial status register (overrun error): When OER is cleared to 0, reception is in progress or completed. When OER is set to 1, an overrun error has occurred during reception.	H'FFAC Bit 5	0

4.4 Description of RAM

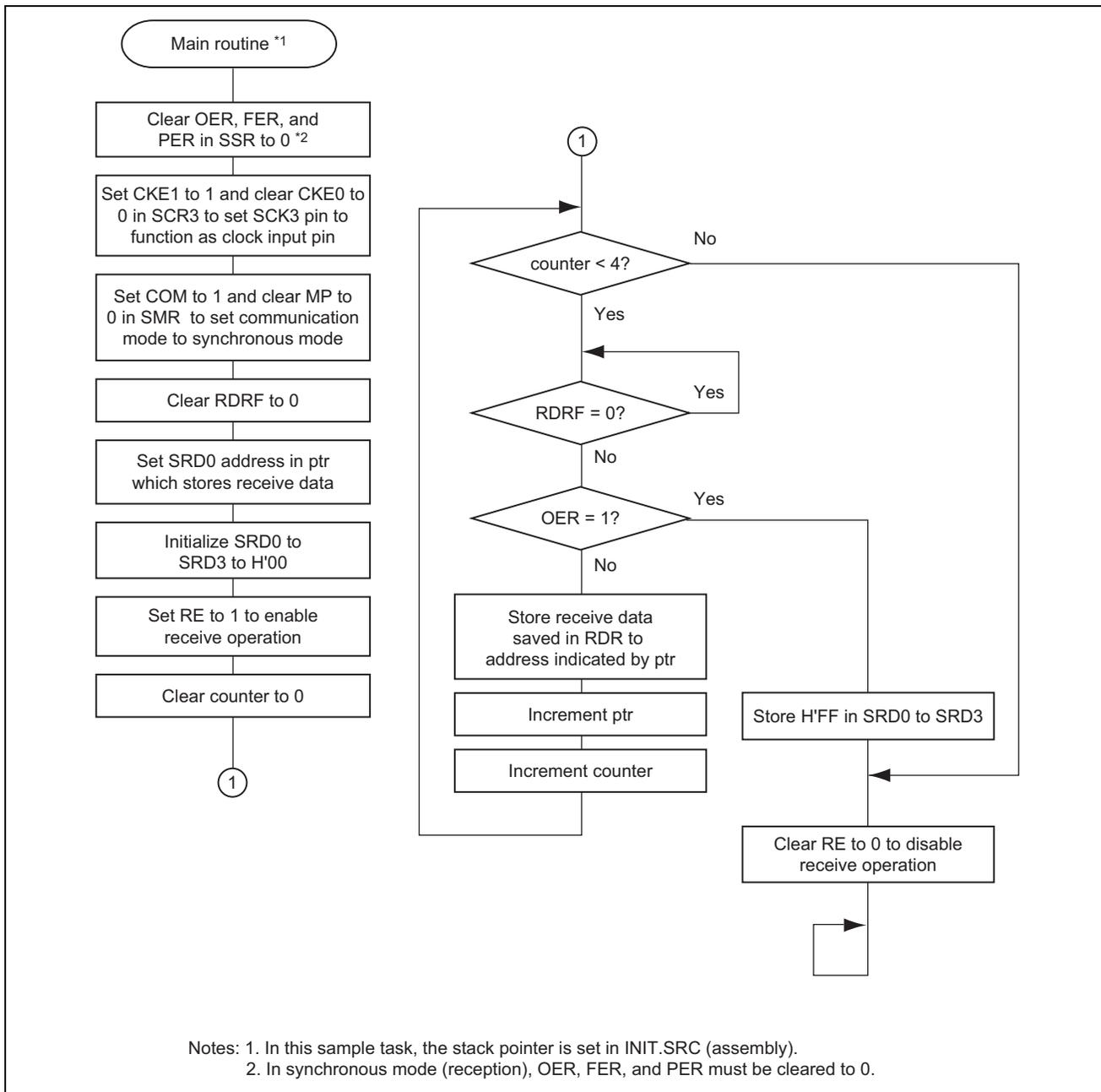
Table 5 describes the RAM used in this sample task.

Table 5 Description of RAM

Label Name	Function	Address	Used in
SRD0	Receives the first byte of receive data in serial data reception in synchronous mode	H'FB80	Main routine
SRD1	Receives the second byte of receive data in serial data reception in synchronous mode	H'FB81	Main routine
SRD2	Receives the third byte of receive data in serial data reception in synchronous mode	H'FB82	Main routine
SRD3	Receives the fourth byte of receive data in serial data reception in synchronous mode	H'FB83	Main routine
counter	8-bit counter for counting four receive operations in serial data reception in synchronous mode	H'FB84	Main routine

5. Flowcharts

1. Main Routine



5.1 Link Address Designation

Section Name	Address
CV1	H'0000
P	H'0100
B	H'FB80

6. Program Listing

INIT.SRC (Program listing)

```

.EXPORT _INIT
.IMPORT _main
;
.SECTION P, CODE
_INIT:
MOV.W #H'FF80,R7
LDC.B #B'10000000,CCR
JMP @_main
;
.END

```

```

/*****/
/*                                     */
/* H8/300H Tiny Series -H8/3664-      */
/* Application Note                    */
/*                                     */
/* 'Synchronous Serial Data Reception' */
/*                                     */
/* Function                            */
/* : Serial Communication Interface     */
/*   Synchronous Serial Interface      */
/*   -Receiving                        */
/*                                     */
/* External Clock : 16MHz              */
/* Internal Clock : 16MHz              */
/* Sub Clock      : 32.768kHz          */
/*                                     */
/*****/

```

```
#include <machine.h>
```

```

/*****/
/* Symbol Definition                  */
/*****/
struct BIT {
    unsigned char  b7:1; /* bit7 */
    unsigned char  b6:1; /* bit6 */
    unsigned char  b5:1; /* bit5 */
    unsigned char  b4:1; /* bit4 */
    unsigned char  b3:1; /* bit3 */
    unsigned char  b2:1; /* bit2 */
    unsigned char  b1:1; /* bit1 */
    unsigned char  b0:1; /* bit0 */
};

```

```

#define SMR_BIT (*(struct BIT *)0xFFA8) /* Serial Mode Register */
#define COM SMR_BIT.b7 /* Communication Mode */
#define MP SMR_BIT.b2 /* Multiprocessor Mode */
#define SCR3_BIT (*(struct BIT *)0xFFAA) /* Serial Control Register 3 */
#define RE SCR3_BIT.b4 /* Receive Enable */
#define CKE1 SCR3_BIT.b1 /* Clock Enable 1 */
#define CKE0 SCR3_BIT.b0 /* Clock Enable 0 */
#define SSR_BIT (*(struct BIT *)0xFFAC) /* Serial Status Register */
#define RDRF SSR_BIT.b6 /* Receive Data Register Full */
#define OER SSR_BIT.b5 /* Overrun Errorr */
#define FER SSR_BIT.b4 /* Framing Errorr */
#define PER SSR_BIT.b3 /* Parity Errorr */
#define RDR *(volatile unsigned char *)0xFFAD /* Receive data Register */

/*****/
/* Function Definition */
/*****/
extern void INIT( void ); /* SP Set */
void main ( void );

/*****/
/* RAM Allocation */
/*****/
unsigned char SRD[4];
unsigned char counter;

/*****/
/* Vector Address */
/*****/
#pragma section V1 /* VECTOR SECTOIN SET */
void (*const VEC_TBL1[])(void) = {
/* 0x00 - 0x0f */
INIT /* 00 Reset */
};

#pragma section /* P */

/*****/
/* Main Program */
/*****/
void main ( void )
{

unsigned char *ptr;

OER = 0; /* Clear OER */
FER = 0; /* Clear FER */
PER = 0; /* Clear PER */

COM = 1; /* Initialize Communication Mode */
MP = 0; /* Initialize Multiprocessor Mode */

CKE1 = 1; /* Initialize Clock Enable 1 */
CKE0 = 0; /* Initialize Clock Enable 0 */

```

```

RDRF = 0; /* Clear RDRF */

ptr = &SRD[0]; /* Initialize Serial Receiving Data Address */

SRD[0] = 0x00; /* Initialize Serial Receiving Data 0 */
SRD[1] = 0x00; /* Initialize Serial Receiving Data 1 */
SRD[2] = 0x00; /* Initialize Serial Receiving Data 2 */
SRD[3] = 0x00; /* Initialize Serial Receiving Data 3 */

RE = 1; /* Start Serial Receiving */

counter = 0; /* Clear counter */

while (counter < 4){ /* Serial Receiving Data Counter 4 Loop */

    while(RDRF == 0){ /* RDRF = 1 ? */
        ;
    }

    if (OER == 1){ /* Overrun Error Flag = 1 ? */
        SRD[0] = 0xFF; /* Overrun Error 0 */
        SRD[1] = 0xFF; /* Overrun Error 1 */
        SRD[2] = 0xFF; /* Overrun Error 2 */
        SRD[3] = 0xFF; /* Overrun Error 3 */
        break;
    }
    else {
        *ptr = RDR; /* Save Serial Receiving Data */
        ptr++; /* Increment Serial Receiving Data Address */
        counter++; /* Increment counter */
    }
}

RE = 0; /* Clear RE */

while(1){
    ;
}

```

Revision Record

Rev.	Date	Description	
		Page	Summary
1.00	Feb.26.03	—	First edition issued
2.00	Jul.22.05	—	Second edition issued

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